

Features

- ESD protected:1500V
- High Dense Cell Design For Extremely Low RDS(ON)
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

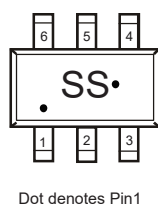
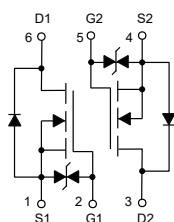
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Thermal Resistance: 395°C/W Junction to Ambient^(Note 2)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V _{DS}	60	V
Gate-Source Voltlage		V _{GS}	±20	V
Continuous Drain Current	T _A =25°C	I _D	0.22	A
	T _A =100°C		0.14	
Pulsed Drain Current ^(Note 3)		I _{DM}	0.88	A
Total Power Dissipation ^(Note 4)		P _D	0.32	W

Note:

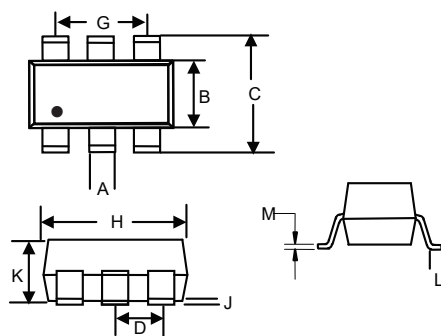
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking Code



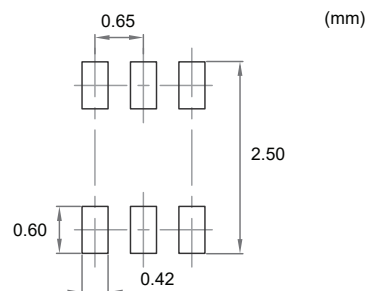
Dual N-Channel MOSFET

SOT-363S



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.006	0.014	0.15	0.35	
B	0.045	0.053	1.15	1.35	
C	0.079	0.087	2.00	2.20	
D	0.026		0.65		TYP.
G	0.047	0.055	1.20	1.40	
H	0.071	0.087	1.80	2.20	
J	-----	0.004	-----	0.10	
K	0.031	0.041	0.80	1.00	
L	0.008	0.016	0.20	0.40	
M	0.003	0.006	0.08	0.15	

Suggested Solder Pad Layout



ELECTRICAL CHARACTERISTICS (Ta=25°C unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	60			V
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	0.8	1.0	1.1	V
Gate-Body Leakage Current	I _{GSS}	V _{GS} =± 20V, V _{DS} =0V			±10	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =55V, V _{GS} =0V			1	μA
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =0.5A		1.1	1.6	Ω
		V _{GS} =4.5V, I _D =0.2A		1.2	2.5	
		V _{GS} =2.5V, I _D =0.1A		1.8	4.1	
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =0.1A		325		mS
Gate Resistance	R _g	f=1 MHz, Open drain		84		Ω
Diode Characteristics						
Continuous Body Diode Current	I _S				0.22	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =0.5A			1.3	V
Reverse Recovery Time	t _{rr}	I _F =0.5A, dI _F /dt=100A/μs		9.4		ns
Reverse Recovery Charge	Q _{rr}			2.2		nC
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1MHz		29.5		pF
Output Capacitance	C _{oss}			4.4		
Reverse Transfer Capacitance	C _{rss}			3		
Total Gate Charge	Q _g	V _{DS} =25V, V _{GS} =10V, I _D =0.5A		1.2		nC
Gate-Source Charge	Q _{gs}			0.32		
Gate-Drain Charge	Q _{gd}			0.16		
Turn-On Delay Time	t _{d(on)}	V _{DD} =25V, V _{GS} =10V, R _{GEN} =25Ω, I _D =0.5A		3.3		ns
Turn-On Rise Time	t _r			3		
Turn-Off Delay Time	t _{d(off)}			12		
Turn-Off Fall Time	t _f			9		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

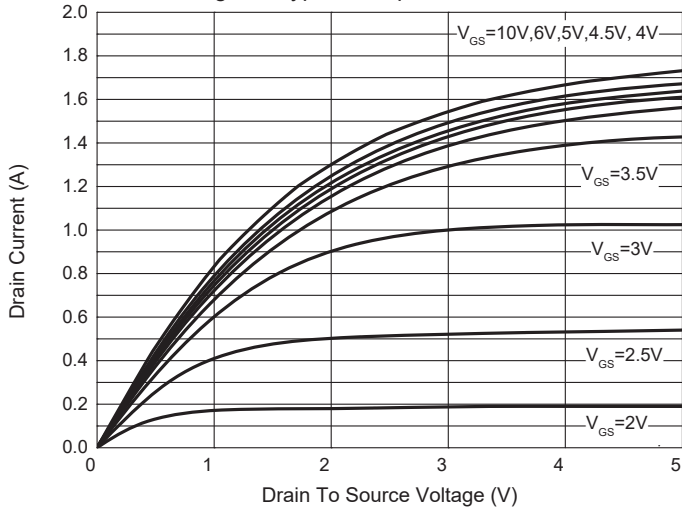


Fig. 2 - Transfer Characteristics

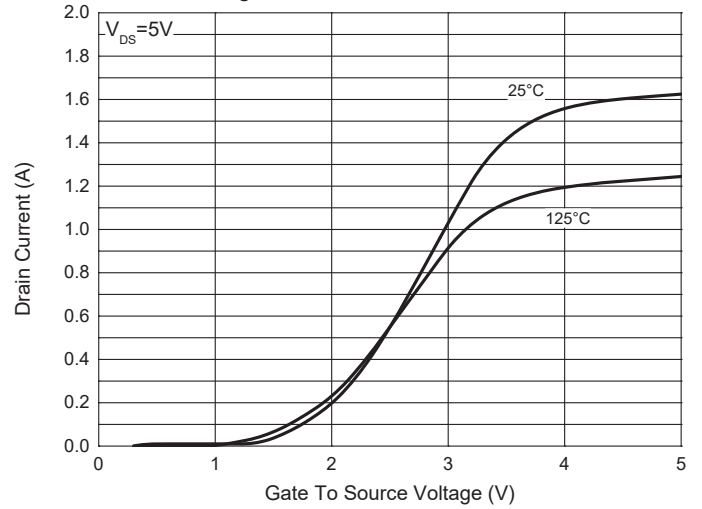


Fig. 3 - $R_{DS(ON)}-V_{GS}$

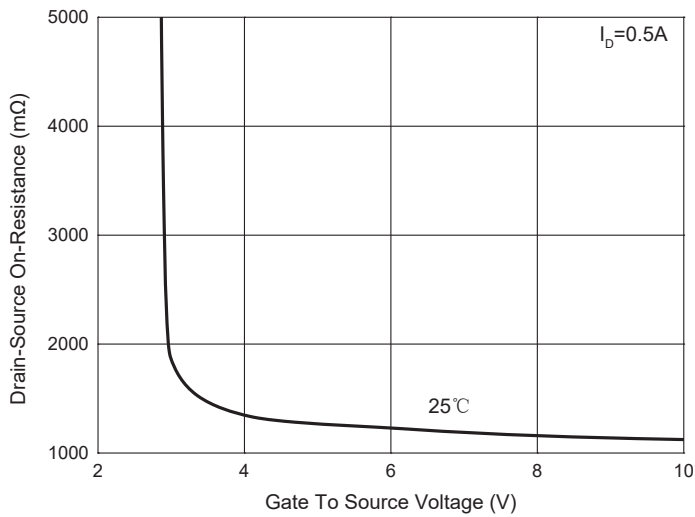


Fig. 4 - $R_{DS(ON)}-I_D$

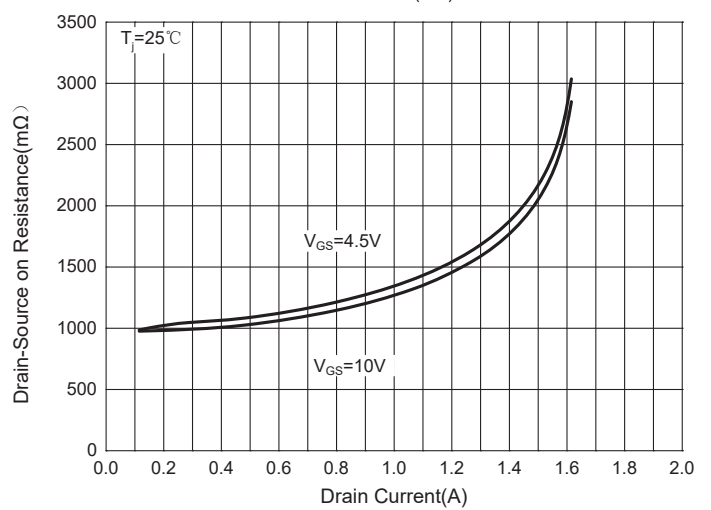


Fig. 5 - Capacitance Characteristics

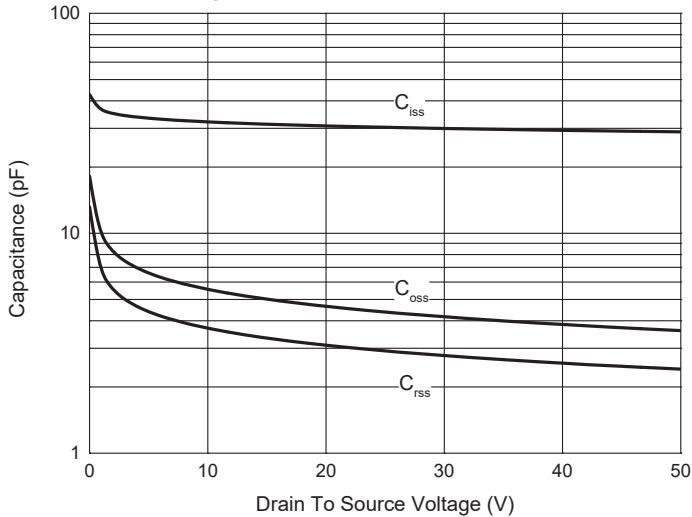
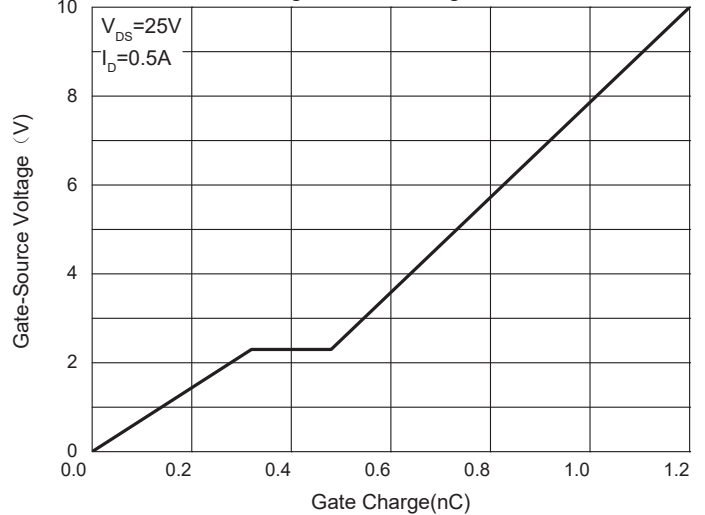


Fig. 6 - Gate Charge



Curve Characteristics

Fig. 7 - Nomalized Threshold Voltage

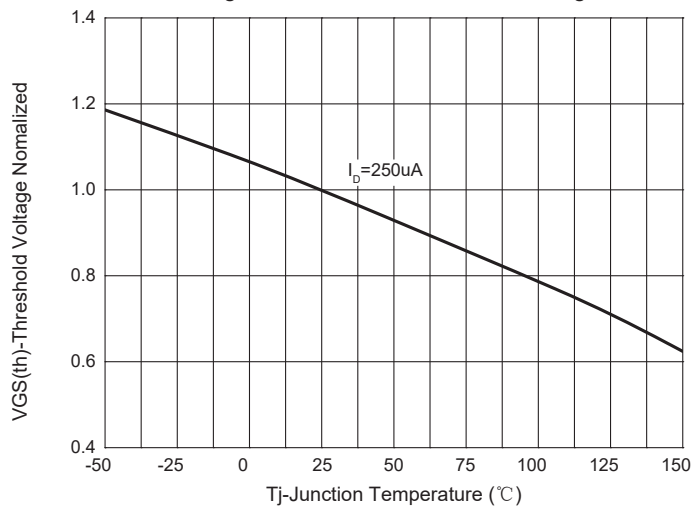


Fig.8-Normalized On Resistance Characteristics

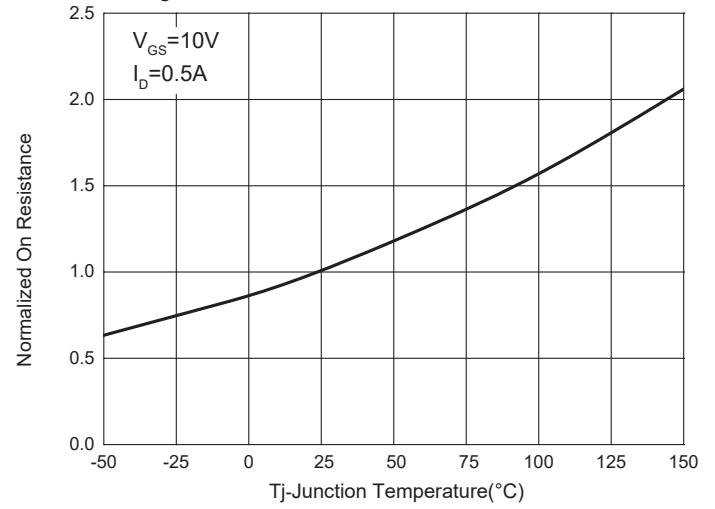


Fig.9 - $I_S - V_{SD}$

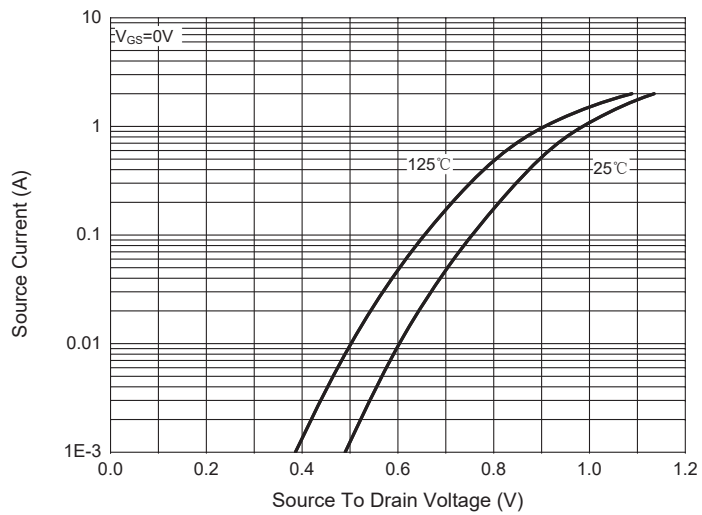


Fig. 10 - Drain Current

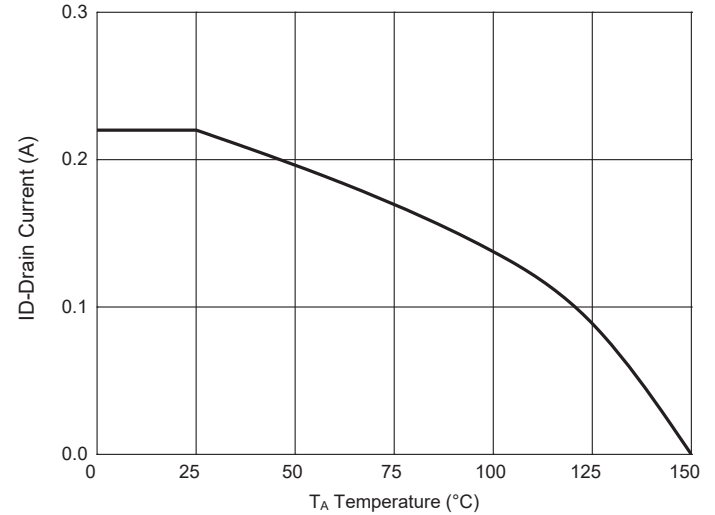
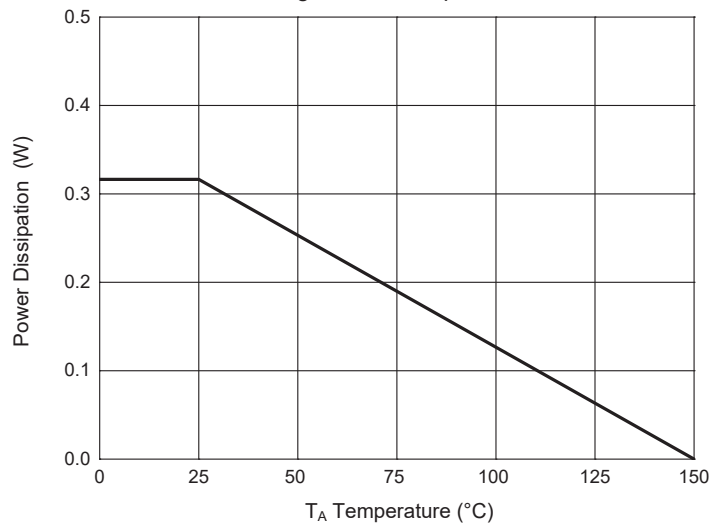


Fig.11-PD Dissipation



Curve Characteristics

Fig. 12 - Safe Operation Area

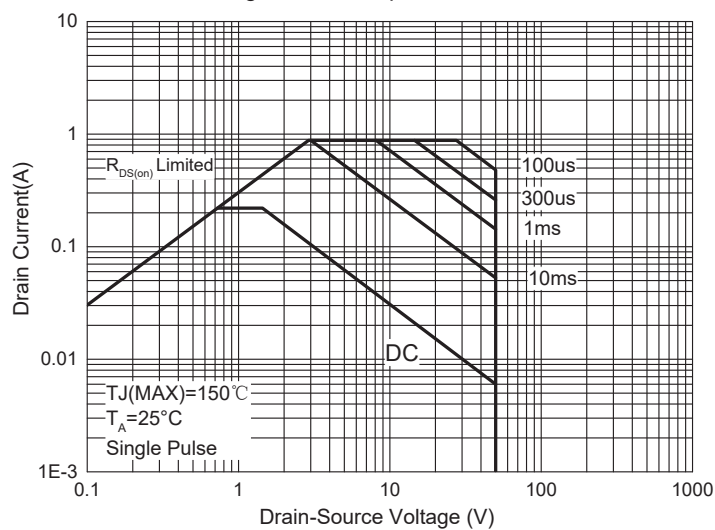
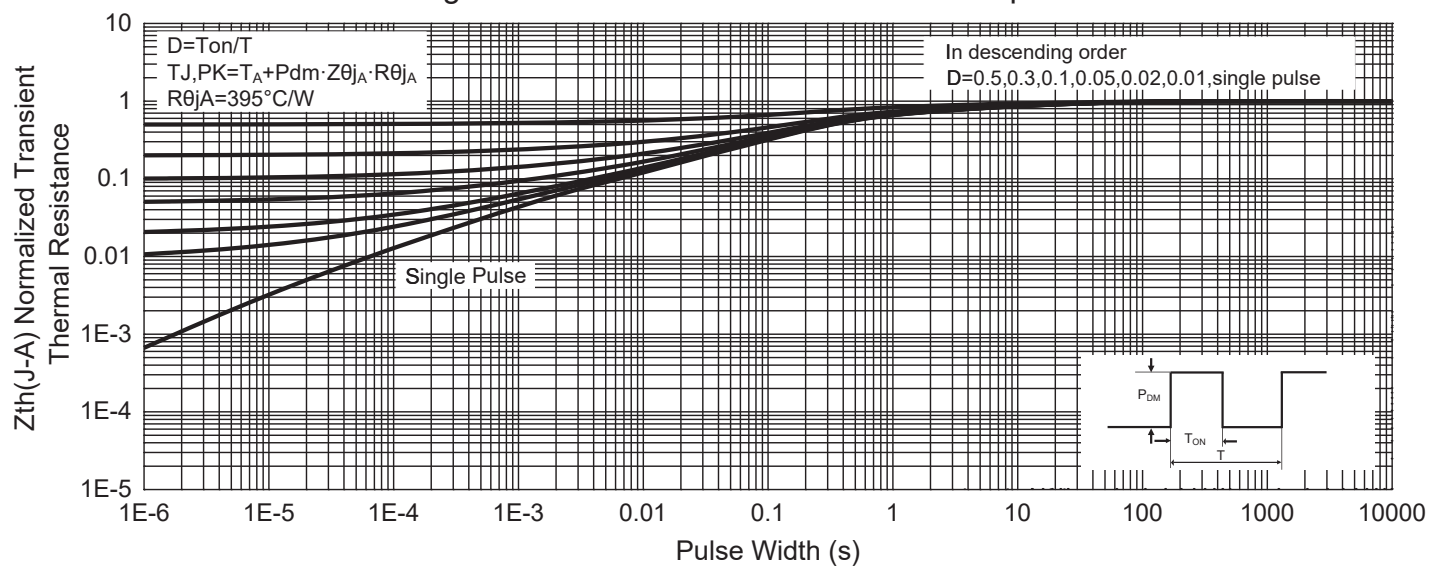


Fig. 13 -Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel
Part Number-TPQ2	Tape&Reel:3Kpcs/Reel

For packaging details, go to our website at <https://www.mccsemi.com/pdf/ProductPackaging/SOT-363S%20Package.pdf>

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